

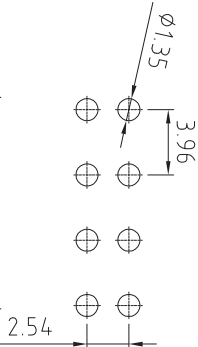
SPECIFICATIONS

CURRENT RATING	7.9 AMP
INSULATOR RESISTANCE	1000 MEGOHMS MIN. Δ
CONTACT RESISTANCE	30m OHMS MAX.
DIELECTRIC WITHSTANDING	1000V AC/DC Δ
OPERATING TEMPERATURE	-40°C TO +105°C Δ
CONTACT MATERIAL	PHOSPHOR BRONZE
INSULATOR MATERIAL	LCP+30% G/F, UL 94V-0
PLATING: 100U" MATTE TIN OVER 30-50U" NICKEL	
SOLDERABILITY	IR REFLOW: 280°C FOR 10 SEC WAVE: 250°C FOR 5-10 SEC MANUAL SOLDER: 380°C FOR 3-5 SEC

MATES WITH: - BB02-UG BB02-UK
BB02-UH
BB02-UJ

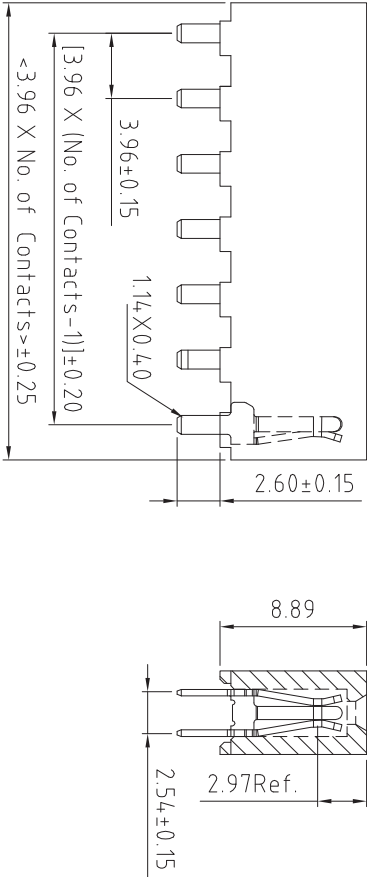
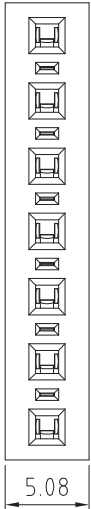
NOTES:

1. GOLD FLASH PLATING IS AVAILABLE UPON REQUEST, PLEASE CONTACT US FOR MORE INFORMATION.
2. RECOMMENDED MATING PIN LENGTH: 5.0MM.



(TOLERANCE: ± 0.05)

RECOMMENDED PC BOARD LAYOUT



HOW TO ORDER

B B 0 2 - U S X X X 2 - M 0 X - 0 0 0 0 0 0

NO. OF CONTACTS:
02 TO 24

CONTACT PLATING OPTIONS:
M = MATTE TIN (STANDARD)

PACKAGE OPTIONS:
3 = TUBE / BOX
5 = TUBE + CAP
6 = TAPE & REEL
8 = TAPE & REEL + CAP

REV.	DATE & DRN	Scale:	THIRD ANGLE	Unstated Tolerances:	Material	Type:
10	3/1/08 - CHC RELEASE	3:1		X ± 0.30	SEE NOTE	BB02-US
11	25/12/08 - NYW DRAWING MODIFICATION.	Drawn: CHC		X ± 0.25		Drawing Number:
12	05/03/09 - NYW REMOVE OTHER PLATING OPTIONS. ADD NOTES 1.	App'd: XXXX	Title: SOCKET	XX ± 0.15	NOT TO SCALE	Sheet 1 of 1
13	25/01/10 - NYW ADD CONTACT DETAIL. ADD NOTES 2.	Date: 22 JUL. '14	Revision: 14	XXX ± 0.10	Unit: mm	E and O E
14	22/07/14 - NYW Δ AMEND SPECIFICATION.					